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C- and O-Band Dual-Polarization Fiber-to-Chip Grating Couplers for Silicon Nitride Photonics

Manuel Kohli,* Daniel Chelladurai, Boris Vukovic, David Moor, Dominik Bisang, Killian Keller, Andreas Messner, Tatiana Buriakova, Michael Zervas, Yuriy Fedoryshyn, Ueli Koch, and Juerg Leuthold*




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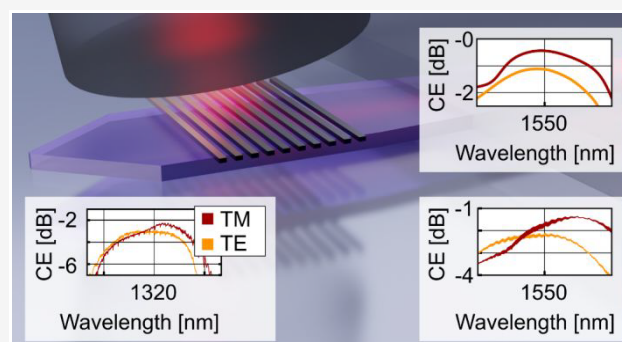
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ABSTRACT: Highly efficient coupling of light from an optical fiber to silicon nitride (SiN) photonic integrated circuits (PICs) is experimentally demonstrated with simple and fabrication-tolerant grating couplers (GC). Fully etched amorphous silicon gratings are formed on top of foundry-produced SiN PICs in a back-end-of-the-line (BEOL) process, which is compatible with 248 nm deep UV lithography. Metallic back reflectors are introduced to enhance the coupling efficiency (CE) from -1.11 to -0.44 dB in simulation and from -2.2 to -1.4 dB in experiments for the TE polarization in the C-band. Furthermore, these gratings can be optimized to couple both TE and TM polarizations with a CE below -3 dB and polarization-dependent losses under 1 dB over a wavelength range of 40 nm in the O-band. This elegant approach offers a simple solution for the realization of compact and, at the same time, highly efficient coupling schemes in SiN PICs.

KEYWORDS: *integrated photonics, fiber-to-chip coupling, grating, silicon nitride*



INTRODUCTION

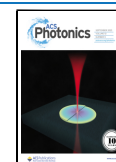
Fiber-to-chip coupling should offer maximum efficiency for high-performance applications while being simple and fabrication tolerant to achieve scalability and allow rapid prototyping. Silicon nitride photonics has gained attention in the past decades due to numerous advantages, such as propagation losses below 0.1 dB/m, dispersion engineering, negligible two-photon absorption, wide transparency window, low thermal sensitivity, and low sensitivity to fabrication variations.^{1–7} Yet, a simple and efficient fiber-to-chip coupling scheme compatible with the SiN process flow is still missing.

To couple light efficiently to the SiN platform, two state-of-the-art methods exist: edge coupling (EC) and grating coupling (GC). EC, on the one hand, is typically known for its high performance in terms of CE, bandwidth, and polarization insensitivity.⁸ EC on SiN further benefits from the low index contrast of the waveguides, making it easier to match the modal size between on-chip waveguides and the optical fiber, with CEs reaching below 1 dB.^{9–11} GC, on the other hand, allows out-of-plane coupling and therefore wafer-level testing, eliminating the need for intensive processing of a sensitive optical facet at the edges of the chips while typically exhibiting relaxed fiber alignment tolerances.⁸ The main drawbacks of GC compared to EC, however, are the lower bandwidth, lower coupling efficiency, and high polarization dependency. SiN grating couplers have an improved bandwidth in comparison to silicon

ones due to the lower index contrast,¹² allowing 1 dB bandwidths of up to 80 nm.¹³ The second challenge of low CE, however, is further hampered on SiN, as lower index contrast results in a lower scattering strength, yielding CEs of -4.2 dB in single-etch SiN gratings.¹² To address this, different approaches have been proposed and demonstrated. Most commonly, multilayer distributed Bragg reflectors^{14–17} consisting of silicon layers beneath the SiN waveguide are employed, yielding CEs as low as -1.17 dB in measurement and -0.31 dB in simulation with a 40 nm 1 dB bandwidth.¹⁴ A different approach consists of defining grating bars on multiple layers,^{13,18–21} requiring precise planarization and lithographical alignment. Experimental results show CE of -1.29 dB and a high 1 dB bandwidth of 80 nm¹³ and simulations of -0.39 dB.²¹ A simpler dual-layer GC is demonstrated with a SiN grown on SOI yielding -2.5 dB CE in the C-band,¹⁹ although deep trenches through a triple-layer consisting of SiN, SiO₂, and Si must be etched. Utilizing the self-imaging method, -1.5 dB CE has been achieved with a staircase grating and a fiber placement over 100

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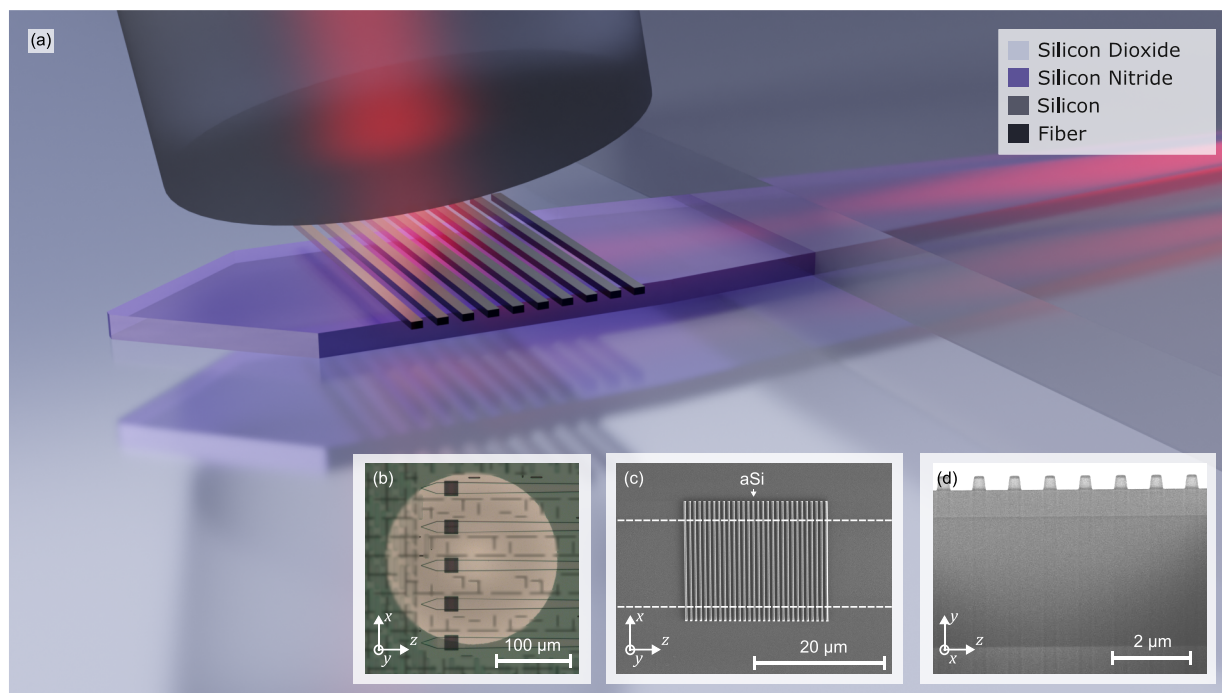


Figure 1. Fabrication-tolerant back-end-of-the-line amorphous silicon overlay grating couplers for the SiN platform. (a) Three-dimensional illustration of the a-Si overlay grating couplers with back reflector. (b) Optical microscope image of fabricated couplers with a circular back reflector. (c) SEM image of couplers without a backside mirror. (d) SEM image of a FIB-generated cross section of the C-band grating coupler without back reflector.

μm above the surface.²² Overcoming the third challenge of polarization dependency is vital for applications, such as on-off keying receivers in optical communications, where polarization of the incoming light is not known a priori.²³ Solutions are more difficult, however, as matching of the Bragg condition for two polarizations at the same time is hindered by the typical birefringence of planar waveguides. Possible solutions include 2D grating couplers demonstrated on silicon,^{24,25} that typically split the polarizations into two different directions. For 1D grating couplers, only a few examples exist, such as combining two grating periods with an experimental CE of -7.8 dB and a polarization dependent loss (PDL) of 0.8 dB over 20 nm²⁶ or a multilayer grating consisting of two SiN and one silicon layer with a demonstrated CE of -4.8 dB and 1dB PDL of over 100 nm.¹⁸ Despite the impressive grating coupler demonstrations, a method that includes fabrication tolerance and simplicity suited for rapid prototyping, while also achieving low loss in the C- and O-bands and polarization insensitivity, is still missing on SiN.

In this work, we introduce a simple and fabrication tolerant method to couple light efficiently into foundry-produced SiN waveguides with silicon overlay gratings; see Figure 1. Coupling efficiencies in the C-band as high as -2.2 dB in measurement and -1.11 dB in simulation are demonstrated, and we show improvement to -1.4 dB in measurement and -0.44 dB in simulation by depositing a metal back reflector without changing any other parameter. The versatility of the approach is further demonstrated with a polarization insensitive design in the O-band reaching -2.2 and -3 dB CE for TM and TE polarizations, respectively. The PDL remains below 1 dB over 40 nm.

The work in this paper is in part based on our results first published at the Optica APC congress in 2021 and 2022.^{27,28}

CONCEPT

The grating coupler presented in this work consists of amorphous silicon (a-Si) grating bars on top of an 800 nm thick SiN layer separated by a thin interlayer oxide (ILO) between the a-Si and the SiN, see Figure 2a. The overlay approach differs from the usual concept, where the grating is within the SiN waveguide. In this approach, we exploit the Bragg diffraction coupling by placing a grating in the a-Si overlay layer. Yet, we also exploit the multimode section in the grating; see Figure 2c. The multimode section enables a diffraction in a Gaussian-like mode profile along the grating section.

Conceptually, one can understand the coupling scheme from Figure 2d. First, a fundamental TE₀ mode is propagated from left to right in the SiN waveguide. A sketch of the mode profile is given in Figure 2b. As it is propagating into the multimode grating section, the mode is mapped onto the three eigenmodes (TE₁, TE₂, TE₃) of the multimode section; see Figure 2c. Initially, the center of the gravity of the light is in the SiN waveguide layer at the bottom. Only a small fraction of the mode is in the overlay layer and is diffracted. As the three modes propagate in the grating multimode section, the modes constructively interfere into the overlay layer, and accordingly, there is stronger diffraction into free space. At some point, the mode fades away and the diffraction decreases. Simulations confirm that this gradual increase and decrease of emission results in an almost ideal excitation of a Gaussian mode profile; see Figure 2d, which is close to the Gaussian mode profile of the fundamental mode in a single mode fiber.

In the next step, we can derive an approximate value for the pitch Λ of the grating. Toward this end, we follow the general design principles of a 1D grating coupler. To diffract the incoming light into a fiber, the phase matching condition or Bragg condition, which relates the wave vectors of the incident

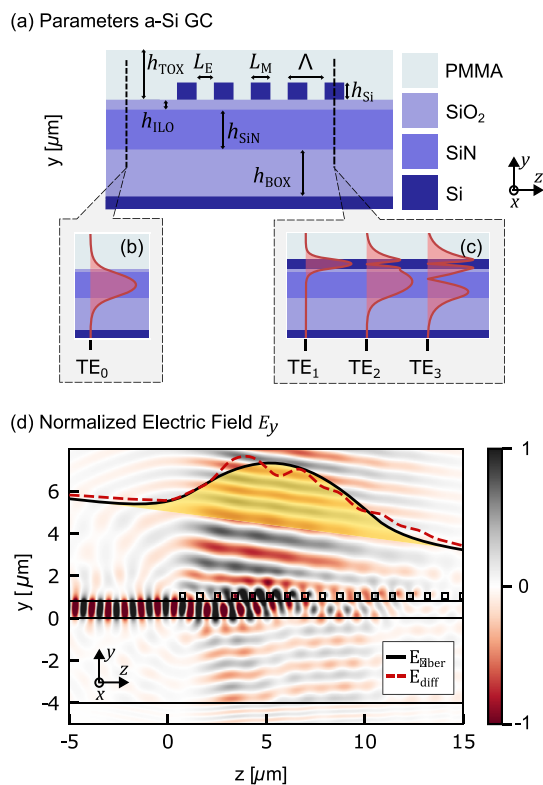


Figure 2. (a) Schematic of the grating coupler with the relevant parameters. (b) Mode in the SiN waveguide without overlay. (c) Modes in the multilayer structure, which have an influence on the diffraction. (d) Normalized electric field in y -direction of the suggested grating coupler, showing that there is an interaction between the different modes.

beam and the diffracted beams, must be fulfilled. This can be expressed as

$$k_y = \beta - |\mathbf{K}| \quad (1)$$

where $k_y = 2\pi \cdot \sin(\theta) \cdot n_{\text{cladding}} / \lambda$ is the wave vector component in y -direction, i.e., the out-of-plane wave, $\beta = 2\pi \cdot n_{\text{GC}} / \lambda$ is the propagation constant of the multimode waveguide and $|\mathbf{K}| = 2\pi / \Lambda$ the grating vector. Assuming a diffraction angle θ toward the normal axis, the phase-matching equation can be rewritten to

$$n_{\text{cladding}} \cdot \sin(\theta) = n_{\text{GC}} - \frac{\lambda}{\Lambda} \quad (2)$$

where n_{GC} is the effective index of the waveguide grating section, n_{cladding} is the refractive index of the cladding, θ is the diffraction angle, λ the center wavelength, and Λ the pitch of the grating.⁸

This equation can be solved for Λ if the effective index of the multimode grating section were known. Here, we approximate n_{GC} by averaging the effective index of the etched and unetched region weighted by the fill factor (FF):

$$n_{\text{GC}} = \text{FF} \cdot n_{\text{M}} + (1 - \text{FF}) \cdot n_{\text{E}} \quad (3)$$

where n_{M} is the effective index in the unetched region, n_{E} is the effective index in the etched region, and $\text{FF} = L_{\text{M}} / (L_{\text{M}} + L_{\text{E}})$ is the fill factor. To apply this approximation to a multimode structure, see Figure 2c, the effective index n_{M} of the unetched part in the grating waveguide can be approximated by a weighted average of the effective indices of the respective modes.¹⁸ The relative weights are given as the fractions by which each mode is excited.

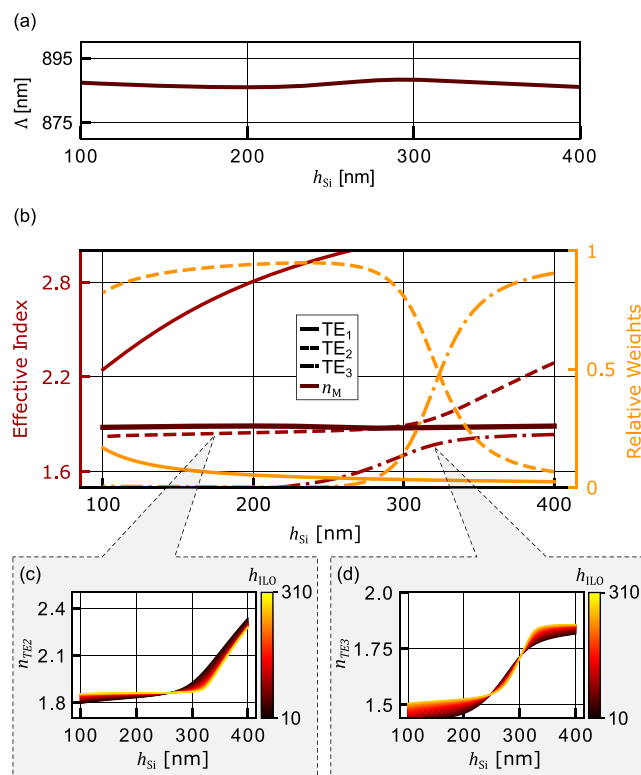


Figure 3. (a) Λ calculated using the weighted average, showing a near constant value in relation to h_{Si} . (b) n_{eff} (left) and the relative weights to TE_0 (right) of the modes TE_1 , TE_2 , and TE_3 in relation to h_{Si} . The weighted approximation of n_{M} is near constant, indicating a large tolerance on to h_{Si} . Simulated to n_{TE_2} (c) and n_{TE_3} (d) in relation to h_{Si} with the colors indicating h_{ILO} . h_{ILO} has a minimal influence on the effective index.

Figure 3a shows the calculated Λ in relation to h_{Si} using the weighted average method with an FF of 0.32. We find a nearly constant value despite a large variation in h_{Si} . This shows a large tolerance of the grating coupler toward a variation of h_{Si} . Following, we investigate the origin of this fabrication tolerance. Toward this goal, we plot in Figure 3b, the effective index (left) and the relative weights (right) of modes TE_1 , TE_2 , and TE_3 from Figure 2c. The relative weights is calculated using eigenmode expansion and refers to the overlap between the three modes to TE_0 , see Figure 2b. Although the individual modes change considerably with h_{Si} , we find that the effective index of the unetched region n_{M} to be near constant for a large range of h_{Si} values. This is an interesting finding as n_{M} is the weighted average of the modes. Next we investigate the variation of n_{M} with the interlayer-oxide thickness (h_{ILO}). Figure 3c shows the effective index of TE_2 and (d) of TE_3 in relation to h_{Si} . The colors indicate h_{ILO} . It can be seen that h_{ILO} has little influence on the effective index of the two modes. This leads to the conclusion that this a-Si overlay grating coupler has a high tolerance on both h_{Si} and h_{ILO} .

EXPERIMENTAL AND METHODS

Fabrication Tolerant C-Band Grating Coupler. In this section, we show the simulation results of the C-band grating coupler for a maximum CE of -0.42 dB. We analyze the fabrication parameters to show the large fabrication tolerance of our approach. The phase-matching condition allows us to pick a reasonable starting condition for the grating around which we

can apply a thorough 2D FDTD analysis. The optimization routine has led us to an optimized grating coupler with parameter values of $h_{\text{Si}} = 290$ nm, $h_{\text{ILO}} = 100$ nm with a pitch of $\Lambda = 888$ nm and fill factor of $\text{FF} = 0.32$. The thicknesses of the SiN ($h_{\text{SiN}} = 800$ nm) and buried oxide ($h_{\text{BOX}} = 4.1$ μm) are kept constant during the optimization.

The wavelength tolerance of the coupling efficiencies of the SiN waveguide toward a SMF fiber tilted by an angle of 7° is shown in Figure 4. The coupling efficiency of a grating coupler

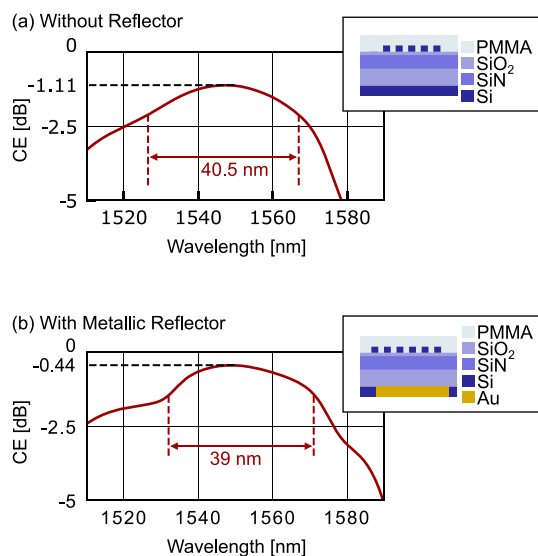


Figure 4. Simulated coupling efficiency for (a) a-Si overlay grating and (b) a-Si overlay grating with metallic mirror. The directionality can be improved by including a metallic mirror, increasing the coupling efficiency from -1.11 to -0.44 dB.

without a back reflector is plotted in Figure 4a. The simulated grating is formed only in the a-Si overlay layer and shows a CE of -1.11 dB with a 1 dB bandwidth of 40.5 nm. Simulations show that within 20 grating bars almost 100% of the light is diffracted. For the upward diffracted field there is a 96.6% (-0.15 dB) modal overlap with the fiber. This leaves the reduction of the downward diffracted light as a main method of improvement.

Indeed, it is found that the CE can be further increased to -0.44 dB by adding a metallic back reflector below the buried oxide (4.1 μm below the SiN); see Figure 4b. There is no need for changing any parameters of the grating coupler. The 1 dB bandwidth stays large with 39 nm.

In a next step, we analyze the fabrication tolerance of our ideal grating coupler without metal mirror; see Figure 2. We sweep in 2D-FDTD the most important parameters, which are h_{Si} , h_{ILO} , Λ , FF, h_{BOX} , and the thickness of the top oxide (h_{TOX}). In each sweep, we kept the other parameters constant. In Figure 5a, the CE of the grating coupler is plotted in relation to h_{Si} . Each color indicates a different h_{ILO} . In (b), we plot the coupling efficiency as a function of h_{ILO} . Each color indicates a different h_{Si} . The individual simulations are indicated by colored dots. We find a 1-dB tolerance of 86 nm for h_{Si} and 139 nm for h_{ILO} , indicating an exceptional large tolerance over the two parameters. In Figure 5c, the dependence of the CE on Λ (red line) and the FF (yellow line) are shown. The CE is reduced by 1 dB when varying Λ by $\Delta\Lambda = 34$ nm and when varying the FF by as much as 0.1455, which corresponds to a detuning of L_{M} by as much as 129 nm. Finally, Figure 5d shows the CE in relation to h_{BOX} (red line) and h_{TOX} (yellow line). Varying h_{BOX} results in an oscillating

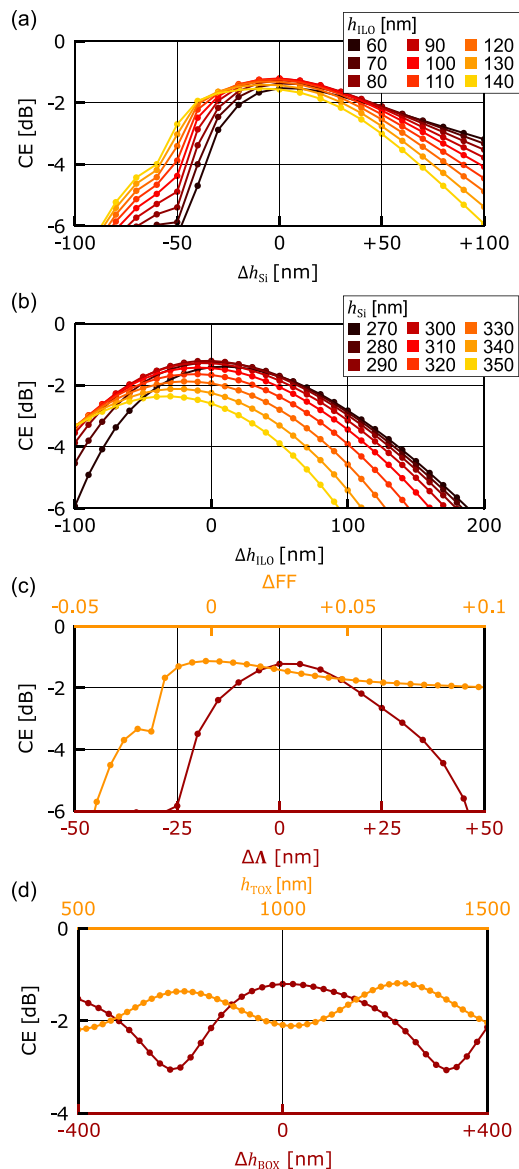


Figure 5. Simulations showing that the suggested grating coupler offers large fabrication tolerance. (a, b) Simulated CE with varying h_{Si} and h_{ILO} showing large fabrication tolerance with a 1 dB tolerance of 86 and 139 nm, respectively. (c) Tolerance sweeps over Λ (red line) and FF (yellow line) with a 1 dB tolerance of 34 nm for the Λ and 0.1455 for the FF. (d) CE in relation to h_{BOX} (red line) and h_{TOX} (yellow line).

behavior arising from constructive and destructive interference of the reflections at the interface of the buried oxide and the silicon handle wafer. From the yellow curve, it is seen that h_{TOX} behaves similarly, and a maximum CE is observed at 1.25 μm . Typically, there is a trade-off between efficiency and bandwidth.^{29,30} If higher optical bandwidth is required, one could potentially utilize an overlay grating material with a lower refractive index than silicon at the price of lower coupling efficiency.

Dual Polarization O-Band Grating Coupler. In the next step, we design and demonstrate a dual-polarization (or polarization insensitive) 1D grating coupler for the O-band using the same principle as the O-band coupler described in the previous section. The use of O-band wavelengths has become the standard for intradatanet interconnects due to the zero-dispersion window around 1310 nm.³¹ Furthermore, the dual-

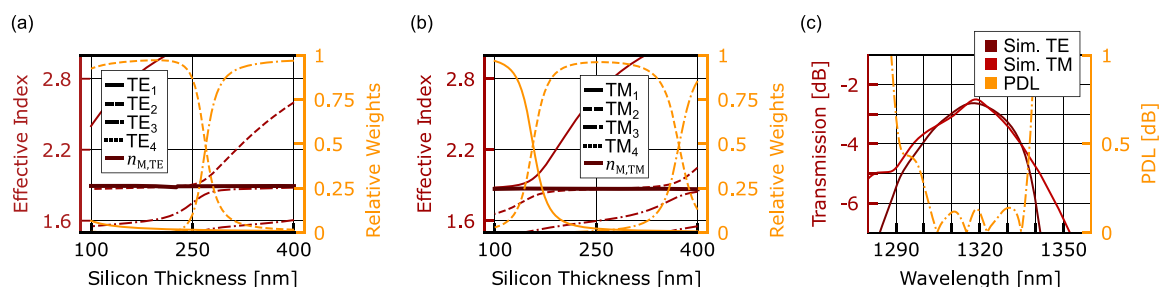


Figure 6. Polarization diverse 1D grating coupler enabled by the multilayer approach. (a) The n_{eff} (left) and the relative weights (right) of the modes TE_1 , TE_2 , TE_3 , and TE_4 for the O-band in relation to h_{Si} . (b) n_{eff} (left) and the relative weights (right) for the TM-polarized modes. (c) Optimized 1D grating coupler for TE and TM operation with a coupling efficiency above 2.5 dB with a polarization-dependent loss (PDL) of less than 0.25 dB for over 30 nm.

polarization capability of integrated components is essential for the realization of polarization multiplexing schemes or the compensation of polarization rotating effects in the system.

We overcome the polarization sensitivity of 1D grating couplers, which arises due to the birefringence of rectangular waveguides, by taking advantage of the large fabrication tolerances to exploit and the degree of freedoms provided by the overlay structure to find a low loss grating coupler for the TE as well as the TM modes. In contrast to the C-band grating coupler, there are not three but four modes in the multilayer structure because of the smaller wavelength. In Figure 6, the effective index (left) and the relative weights (right) of modes (a) TE_1 , TE_2 , TE_3 , and TE_4 and (b) TM_1 , TM_2 , TM_3 , and TM_4 is shown in relation to h_{Si} . Similar to the C-band, the weighted average is almost constant. With the addition of TE_0 and TM_0 , the effective indices in the grating region can be designed to be nearly equal for TE and TM polarization ($n_{\text{GC,TE}} \approx n_{\text{GC,TM}}$). This yields a similar pitch through the approximation of the phase matching equation. To achieve similar behavior in the C-band, control over h_{BOX} and h_{SiN} is necessary, which are fixed by the foundry in our work. We used the weighted average approximation described in the Concept section to calculate a starting point for the optimization routine. The result can be observed in Figure 6c. The simulated grating coupler operates for both polarizations with the same fiber angle and position, resulting in a CE of -2.6 dB. The polarization-dependent loss, defined as $\text{PDL} = |\text{CE}_{\text{TE,dB}} - \text{CE}_{\text{TM,dB}}|$, is below 0.15 dB over a wavelength range of 30 nm. The grating has a pitch of $\Lambda = 765$ nm and a fill factor of 0.484. The thickness of the a-Si is 305 nm and of the interlayer oxide 100 nm.

Fabrication. The a-Si overlay grating coupler was fabricated with a back-end-of-the-line process on a foundry-produced thick SiN platform. Amorphous silicon was deposited on a planarized sample with plasma-enhanced chemical vapor deposition, patterned with electron beam lithography, and etched by using inductively coupled reactive ion etching (ICP-RIE) in HBr plasma. The fabrication of the devices with metallic reflector included a backside oxide etch with ICP-RIE and a subsequent deep reactive ion etching (DRIE) of the Si substrate. Electron beam evaporation was used to deposit gold on the backside. Figure 1d shows a cross-sectional scanning electron microscopy (SEM) image generated with a focused ion beam of the grating coupler without metallic reflector. Figure 1b shows an optical microscopy image of the grating coupler with a metallic back reflector on the same chip. Finally, the chip was coated with poly(methyl methacrylate) (PMMA) as cladding material. It serves as an easy-to-deposit substitute for SiO_2 with a comparable refractive index ($n \approx 1.48$). We fabricated the

dual-polarization grating coupler in the same way as the C-band gratings with $h_{\text{Si}} = 305$ nm and without a back reflector. The SEM image of the O-band grating coupler is found in Figure 1c.

RESULTS AND DISCUSSION

Measurement of C-Band Grating Coupler. Figure 7 shows the coupling efficiencies as a function of the spectra of the

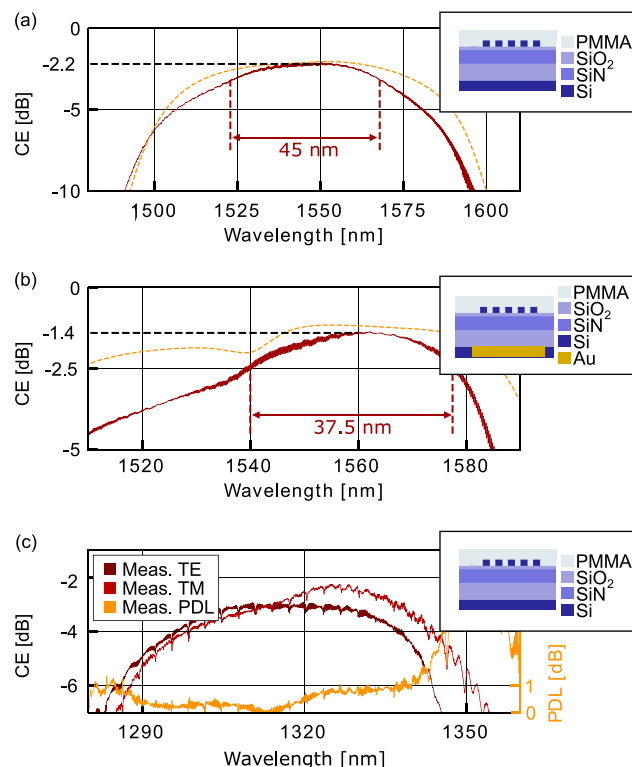


Figure 7. Measured (red line) and simulated (yellow line) coupling efficiency of the grating couplers versus simulated value with the 1 dB bandwidth. (a) CE of the TE C-band grating coupler without a back reflector. (b) CE of the TE C-band grating coupler with a back reflector. (c) Measurement result of the polarization diverse grating coupler with a measured PDL below 1 dB for over 40 nm.

a-Si overlay grating couplers presented in this work. The red curves are from measurements. The yellow curves correspond to the simulated grating coupler. The parameters of (a) were adapted to the fabrication result through thickness measurements and SEM images of cross sections generated with a focused ion beam. For (b), we assume the same parameters with the only difference of a 50 nm thinner h_{BOX} due to over etching.

Table 1. Overview of SiN Grating Coupler Results Found in the Literature

GC type	platform	mirror	CE (meas.; dB)	λ_{\max} (nm)	CE (sim.; dB)	1 dB BW (nm)
multilayer PE DBR ¹⁴	500 nm SiN	DBR	-1.17	1571	-0.45	40
multilayer FE DBR ¹⁴	400 nm SiN	DBR	-1.24	1572	-0.31	39
multilayer Si-SiN ¹³	400 nm SiN on SOI	Si gratings	-1.29	1536	-1.0	82
self-imaging stair-case GC ²²	600 nm SiN		-1.5	1550	-0.66	60 (3 dB)
multilayer FE DBR ¹⁶	325 nm SiN	DBR	-1.75	1550	-1.0	76.34 (3 dB)
multilayer FE DBR ¹⁵	400 nm SiN	DBR	-2.29	1573	-1.135	49
multilayer FE DBR ¹⁷	400 nm SiN	DBR	-2.5	1490	-2.32	53
multilayer GC ¹⁹	600 nm SiN on SOI	Si gratings	-2.5	1560	-2.13	65
multilayer GC ²⁰	220 nm dual-layer SiN		-2.56	1550	-2.28	54.1
FE GC ¹²	400 nm SiN		-4.2	1570	-3.9	67
multilayer GC ³²	100 nm SiN		-5.0	1540	-3.8	75 (3 dB)
this work: a-Si overlay GC	800 nm SiN		-2.2	1550	-1.25	45
this work: a-Si overlay GC with mirror	800 nm SiN	metal	-1.4	1560	-0.42	37.5

Table 2. Polarization Diversity Schemes for 1D GC on Si or SiN Found in the Literature

GC type	platform	CE (meas.; dB)	λ_{\max} (nm)	PDL < 1 dB (meas.; nm)	PDL < 1 dB (sim.; nm)
multilayer PE GC ³³	polysilicon on SOI	-3.93	1550	77 (1.28 dB)	55
multilayer FE GC ¹⁸	dual-layer 450 nm SiN on SOI	-4.8	1310	>100	69
zero-birefringence FE GC ³⁴	SOI	-6.1	1274	73	41
PE nonuniform GC ²⁶	SOI	-7.2	1570	22	70
this work: a-Si overlay GC	800 nm SiN	-2.3	1325	32	41

The plots in Figure 7a show the CEs of the a-Si overlay GCs without a back reflector. Coupling efficiencies of -2.2 dB were found with a 1 dB bandwidth of 45 nm. By adding a metallic back reflector, see Figure 7b, a CE of -1.4 dB and a 1 dB bandwidth of 37.5 nm was measured. The GCs of Figure 7a,b have identical geometries, and they stem from devices fabricated on the same chip. Characterization of the devices were conducted with optical transmission measurements using a tunable laser source in the C-band. A polarization controller was used to set the correct polarization. The setup losses were subtracted from the measurement and the SiN waveguides were assumed to be lossless. In practice we found propagation losses of ~0.4 dB/cm. Yet, as our waveguides were as short as 1.5 mm, we disregarded such losses. Standard 90°-cleaved single-mode SMF28 fibers were used for coupling. The measurements and simulations of the a-Si GC are in very good agreement. The lower efficiency in the measured vs the simulated GC with metallic mirror potentially arises from utilizing the buried oxide as an etch stop for the DRIE process, which leads to a slightly thinner BOX thickness. Overetching had to be conducted to make sure all silicon is removed.

Table 1 summarizes different approaches for low loss grating couplers on the SiN platform and compares our measurements to the literature results. Our result of -2.2 dB is, to the best of our knowledge, the highest efficiency reported for a single-etch grating coupler without back reflector. The efficiencies of the a-Si grating coupler with a metallic mirror as shown in this work are comparable to the more complex DBR approaches.

Measurement of O-Band Dual Polarization Grating Coupler. Figure 7c shows the measured results of -2.3 dB with a 32 nm 1 dB bandwidth for the TM polarization and -3.0 dB CE with a 41 nm 1 dB bandwidth for the TE polarization. The PDL is below 1 dB over a wavelength range of 40 nm. The measurement was conducted using a similar setup as for the C-band grating coupler with a tunable laser source in the O-band. Polarization-sensitive reference grating couplers were used to set and adjust the polarizations with a polarization controller.

Analog to the C-band, we subtracted the setup losses and assumed that the SiN waveguides are lossless. The angle of the standard 90°-cleaved single-mode SMF28 fibers was set to 10.5° for both polarizations. The small dips in the spectrum originate from ring resonators coupled to the SiN waveguide. Table 2 summarizes the literature results for polarization diversity schemes with 1D grating couplers for reference. We find that our approach offers a significantly higher coupling efficiency than other 1D grating approaches on silicon or silicon nitride photonics. Furthermore, in contrast to literature, we do not see an efficiency penalty in comparison to single polarization grating couplers.

CONCLUSION

In this work, we introduce highly efficient grating couplers for an emerging SiN platform. The single etch a-Si gratings have been fabricated by a back-end-of-the-line process at the wafer-scale on foundry-produced SiN waveguides. For TE-polarized light in the C-band, simulations yield high CEs of -1.11 without and -0.44 dB with metallic mirrors. In experiments, we found CEs of -2.2 and -1.4 dB, respectively. Furthermore, we demonstrate efficient and polarization-insensitive 1D grating couplers in the O-band. We measure a PDL below 1 dB within a 40 nm spectral window with a CE of -2.3 dB (TM) and -3.0 dB (TE) in the same device for coupling to a fiber aligned along the same fiber angle. Our approach offers a solution to a pending problem and provides ease of fabrication by taking advantage of a fabrication-tolerant design that is compatible with wafer-scale testing. The low fabrication complexity might help to further leverage the SiN platform.

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ABBREVIATIONS

SiN, silicon nitride; PICs, photonic integrated circuits; GC, grating couplers; BEOL, back-end-of-the-line; CE, coupling efficiency; EC, edge coupling; GC, grating coupling; PDL, polarization-dependent loss; ILO, interlayer-oxide; a-Si, amorphous silicon; FF, fill factor; TOX, top oxide; BOX, buried oxide; ICP-RIE, inductively coupled reactive ion etching; DRIE, deep reactive ion etching; SEM, scanning electron microscopy; PMMA, poly(methyl methacrylate); DBR, distributed Bragg reflectors

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